Description

KAU0511P1 polymeric ESD suppressor help protect sensitive electronic equipment against electrostatic discharge (ESD) without distorting data signals. This protection is a result of its ultra-low capacitance of only 0.05 pF (I/O to GND), and it can be used to help equipment to pass IEC61000-4-2 level 4 test (15KV air, 8KV contact discharge).

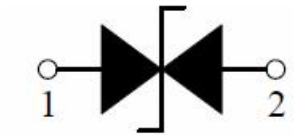
(EIA Size) 0402



Features

- Ultra low capacitance,0.05pF(typ.).
- Fast response time(<1ns).
- Low leakage current(<10nA).
- Bi-directional, single line protection.
- IEC61000-4-2(Contact): 8KV, IEC61000-4-2(Air) :15KV.

Equivalent Circuit



Applications

- Smart Phone/Mobile Internet Device.
- Laptop/Desktop Computer.
- Antennas (Cell Phones, GPS…).
- USB 3.0,USB 3.1 and high speed interface.

General Characteristics

Parameter	Max	Unit
Contact Discharge Voltage Per IEC61000-4-2	8	KV
Air Discharge Voltage Per IEC61000-4-2	15	KV
Operating Temperature	-55 to +125	℃
Storage Temperature	-40 to +85	℃

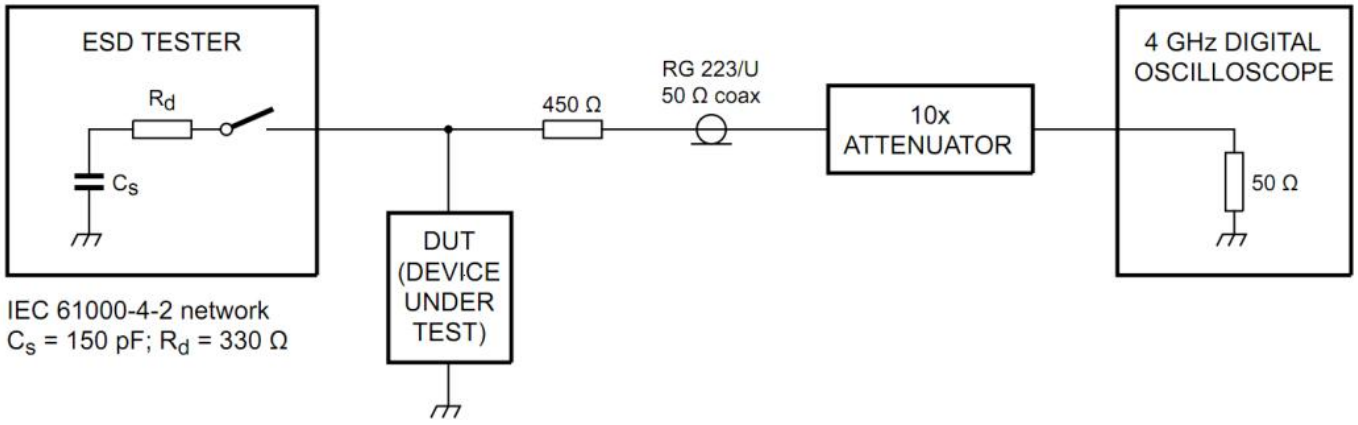
Electrical Characteristics (T_A = 25℃)

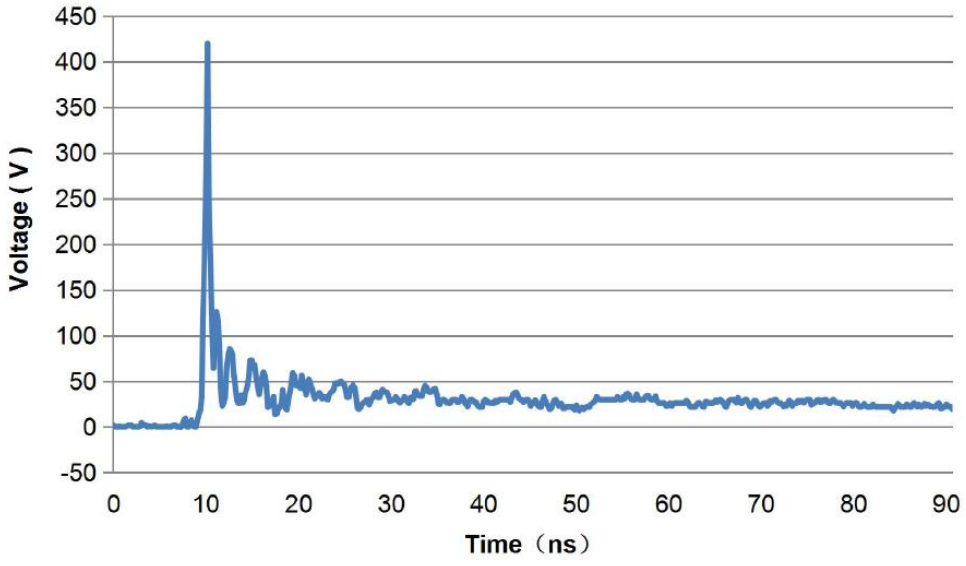
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Continuous Operating Voltage	V_{DC}	--	--	--	5	V
Trigger Voltage	V_T	IEC61000-4-2 8KV contact discharge	--	450	--	V
Clamping Voltage	V_C	IEC61000-4-2 8KV contact discharge	--	40	--	V
Leakage Current	I_L	DC 5V shall be applied on component	--	--	10	nA
Capacitance	C_P	Measured at 10MHz	--	0.05	--	pF
ESD Pulse Withstand	Pulses	IEC61000-4-2 8KV contact discharge	1000	--	--	--

Note:

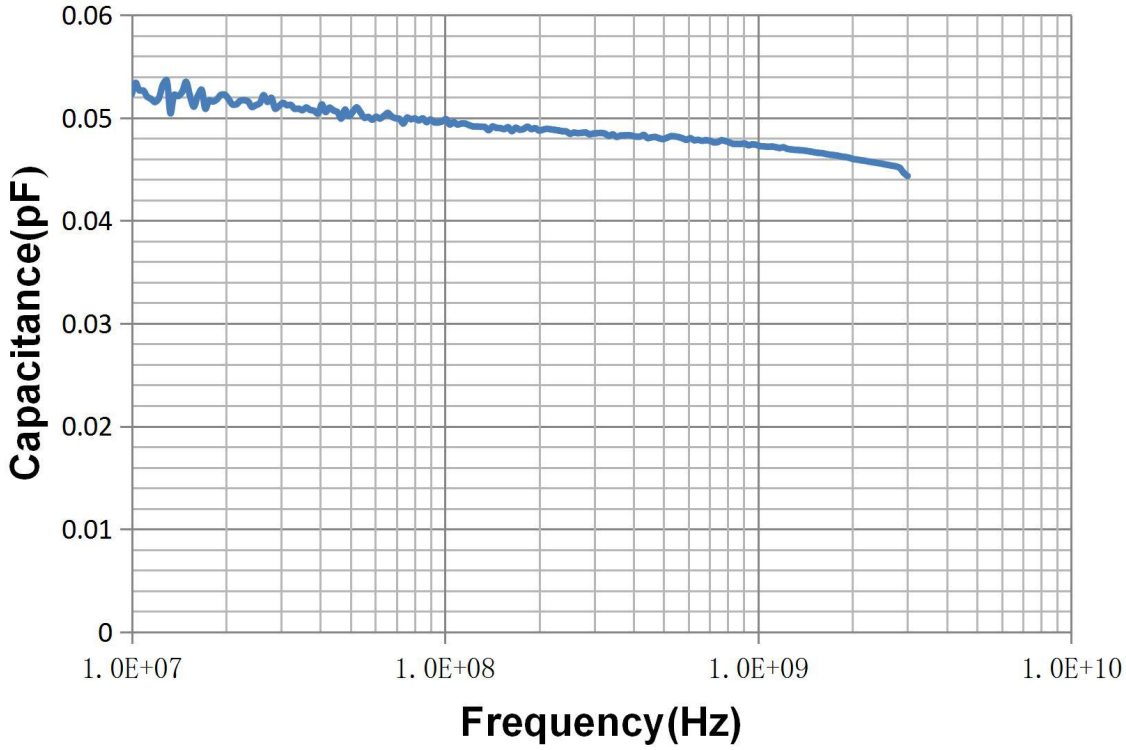
Trigger and clamping voltage are measured per IEC 61000-4-2, 8KV contact discharge method.

Typical ESD Response（IEC 61000-4-2, 8KV contact discharge）

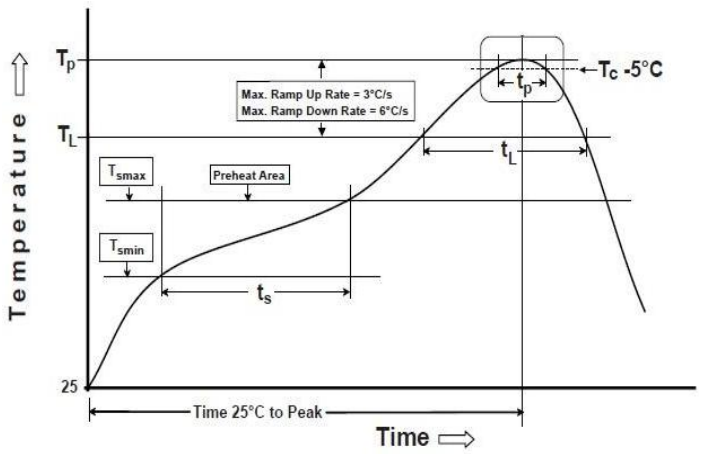




Typical Device Capacitance VS. Frequency



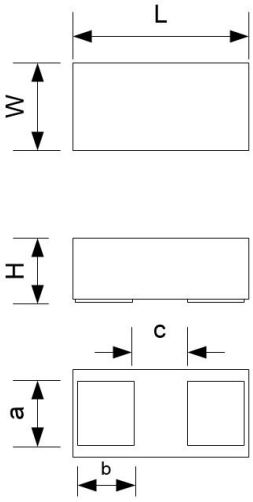
Soldering Parameters



Profile Feature		Pb-Free Assembly
Pre Heat	Temperature Min (T_{smin})	150℃
	Temperature Max (T_{smax})	200℃
	Time (T_s) from (T_{smin} to T_{smax})	60-120 seconds
Ramp-up Rate (T_L to T_P)		3℃/second max.
Liquidus Temperature (T_L)		217℃
Time (t_L) maintained above T_L		60-150 seconds
Peak Package Body Temperature (T_P)		$260^{+0/-5}$℃
Time (t_P)* within 5℃ of the Specified Classification Temperature (T_C)		30* seconds
Ramp-down Rate (T_P to T_L)		6℃/second max.
Time 25℃ to peak Temperature		8 minutes Max
* Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.		

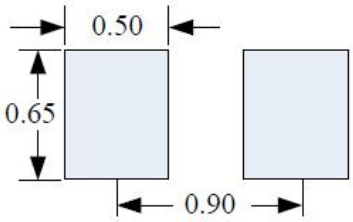
Package Dimension

Package Outline



Dimension	Unit: Millimeters		
	Min.	Typ.	Max.
L	0.98	1.00	1.03
W	0.48	0.50	0.53
H	0.35	0.38	0.40
a	0.35	0.38	0.40
b	0.30	0.30	0.35
c	0.24	0.26	0.29

Recommended Solder Pad Footprint



Sizes in mm

Notes：

This solder pad layout is for reference purposes only.

Unikeyic Electronics

Global Electronic Components Distributor

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KUU:

1N60PW B340A SMBJ160CA SMDJ16A KNTC0603/10KF3950 LSMD050 MSMD050/24 MSMD150 PESD12VS1UB SMBJ6.0CA WNM4002-3/TR LSMD150 SJD12C15L01 SMF15A ESD05V32D-LC 1N5819W S4 BV03C ESD0301BU KMOV0402E180C030T SMDJ7.0A ESD3V3D523-2U GBLC15CI K1N5819HW-7-F MBR0540-7-F SD103AWS S4 SMBJ17A SMDJ9.0A SM712.TCT SMDJ7.5CA SMDJ8.5A